

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Dario L Goldfarb	07/26/2006
RECEIVING PARTY DATA	
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State/Country:	NEW YORK
Postal Code:	10504
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11500663
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Total Attachments: 1 source=YOR920060311US1assignment#page1.tif	

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Assignment

INVENTOR AND CITY Whereas, I
(1) Dario Leonardo Goldfarb of Mohegan Lake
County of Westchester and State of New York
TITLE have invented certain improvements in
Tunable Contact Angle Process for Immersion Lithography Topcoats and
Photoresists
DATES THAT INVENTORS SIGNED THE DECLARATION and executed, respectively, a United States patent application therefore on
(1) 2006.

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said applications to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed

CITY AND
DATE

(1) at
on July 26th, 2006.


DARIO LEONARDO GOLDFARB
FIRST NAME MIDDLE INITIAL LAST NAME
SIGNATURE
INVENTOR